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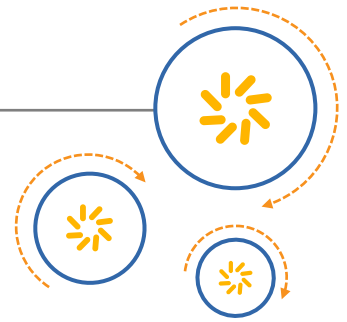
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RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

SAW Components

SAW filter

Automotive telematics

Series/type:	B3912
Ordering code:	B39242B3912U410
Date:	January 30, 2013
Version:	2.2

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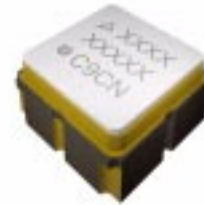
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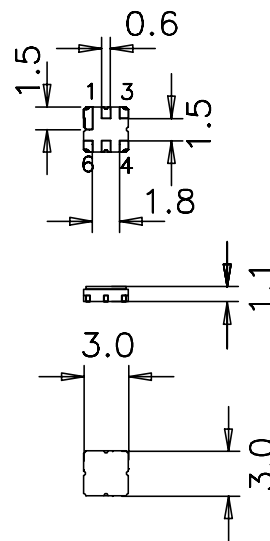
Data sheet


Application

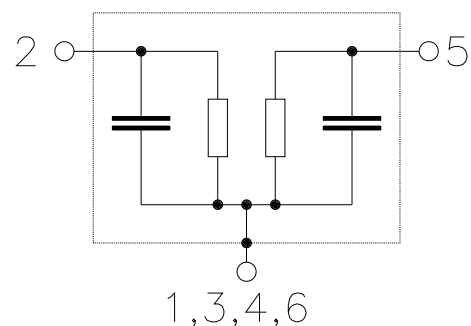
- Low-loss RF filter for automotive telematics


Features

- Package size 3.0 x 3.0 x 1.1 mm³
- Package code DCC6C
- RoHS compatible
- Approximate weight 0.037 g
- Package for **Surface Mount Technology (SMT)**
- Ni, gold-plated terminals
- Lead free soldering compatible with J - STD20C
- AEC-Q200 qualified component family
- **Electrostatic Sensitive Device (ESD)**


Pin configuration

- 2 Input
- 5 Output
- 1,3,4,6 Case ground



Data sheet


Characteristics

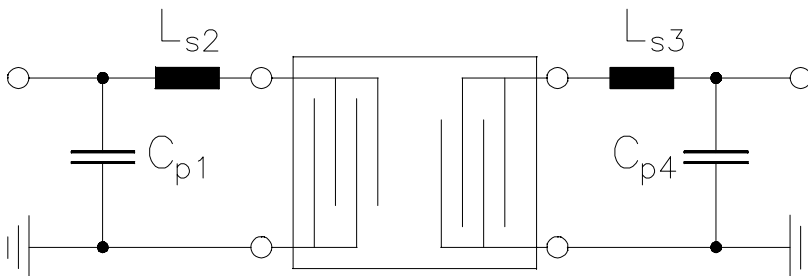
Temperature range for specification: $T = -40\text{ °C to }+85\text{ °C}$
 Terminating source impedance: $Z_S = 50\ \Omega$ and matching network
 Terminating load impedance: $Z_L = 50\ \Omega$ and matching network

		min.	typ. @ 25 °C	max.	
Center frequency	f_C	—	2448.50	—	MHz
Maximum insertion attenuation	α_{\max}	—	1.7	3.0	dB
2400.00 ... 2497.00 MHz					
Amplitude ripple (p-p)	$\Delta\alpha$	—	0.7	2.0	dB
2400.00 ... 2497.00 MHz					
VSWR					
Input	2400.00 ... 2497.00 MHz	—	1.5	2.0	
Output	2400.00 ... 2497.00 MHz	—	1.5	2.0	
Attenuation	α				
	50.00 ... 2300.00 MHz	20	24	—	dB
	2600.00 ... 3500.00 MHz	22	26	—	
	3500.00 ... 5000.00 MHz	25	33	—	


Maximum ratings

Operable temperature range	T	-45/+125	°C	
Storage temperature range	T _{stg}	-45/+125	°C	
DC voltage	V _{DC}	6	V	
Source power	P _S	20	dBm	source impedance 50 Ω

Data sheet


Matching network to 50 Ω (element values depend on pcb layout and equivalent circuit)


$$C_{p1} = 1.0 \text{ pF}$$

$$L_{s2} = 2.7 \text{ nH}$$

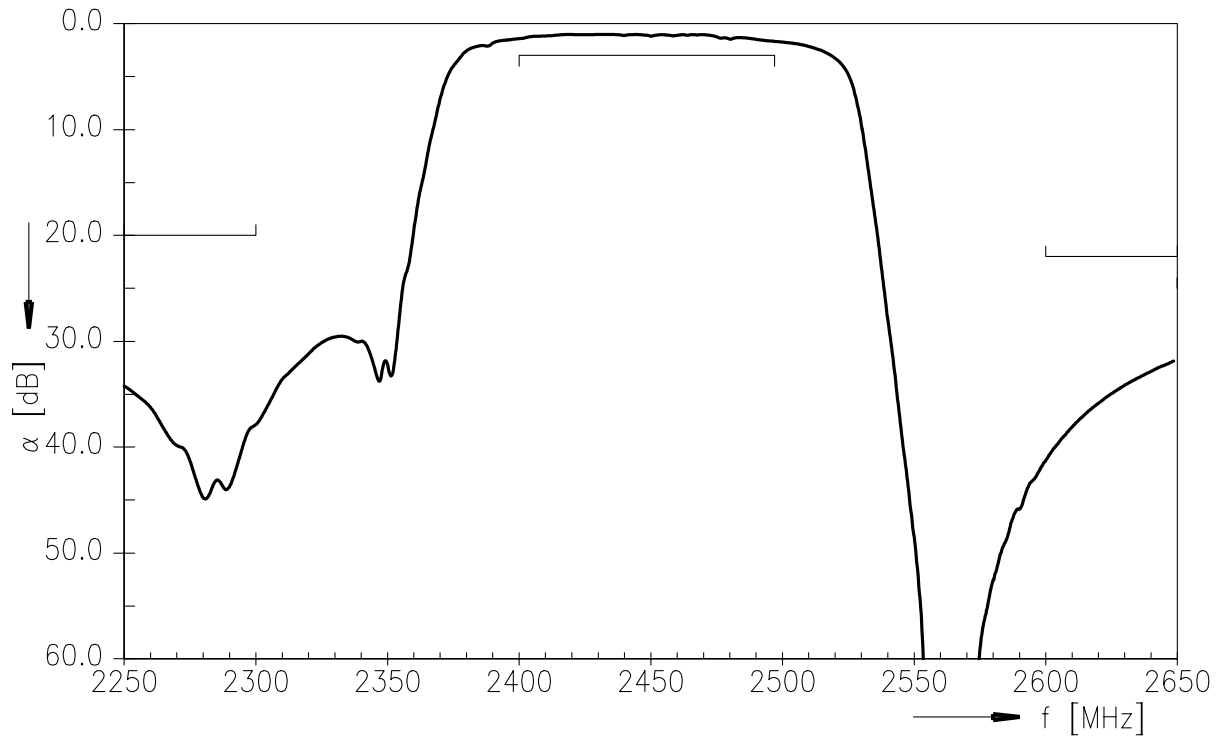
$$L_{s3} = 2.7 \text{ nH}$$

$$C_{p4} = 1.0 \text{ pF}$$

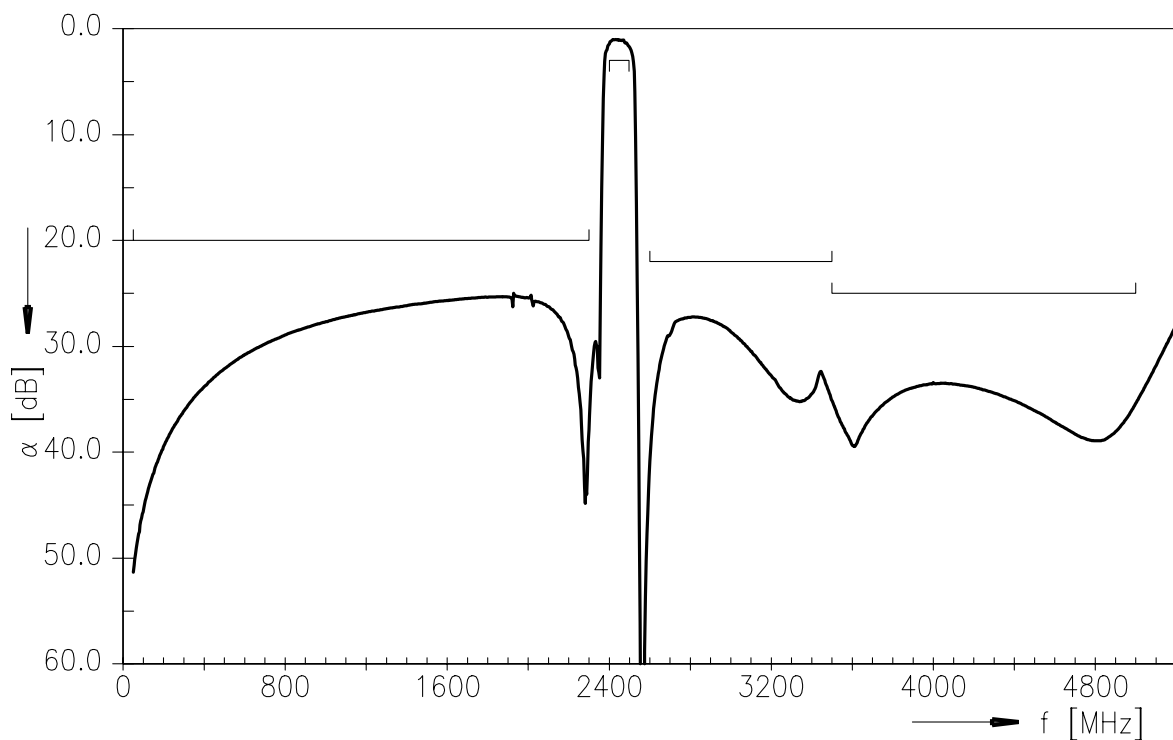
Data sheet



Transfer function



Transfer function (wideband)





ESD protection of SAW filters

SAW filters are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, “ESD matching” has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended “ESD matching” topologies.

For wideband filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

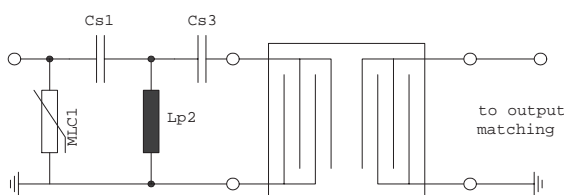


Fig. 1 MLC varistor plus ESD matching

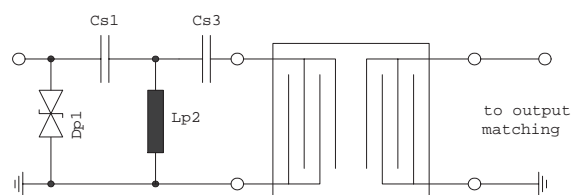


Fig. 2 Suppressor diode plus ESD matching

In cases where minor ESD occur, following simplified “ESD matching” topologies can be used alternatively.

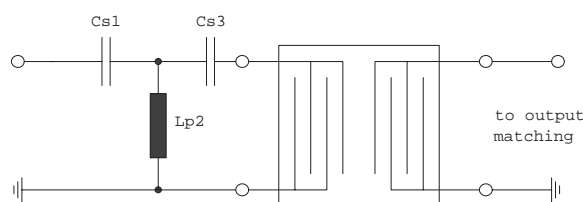


Fig. 3 3rd order high-pass structure for basic ESD protection

In all three figures the shunt inductor Lp2 could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available pcb space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements

For further information, please refer to EPCOS Application report:

“ESD protection for SAW filters”.

This report can be found under www.epcos.com/rke. Click on “Applications Notes”.


References

Type	B3912
Ordering code	B39242B3912U410
Marking and package	C61157-A7-A67
Packaging	F61074-V8228-Z000
Date codes	L_1126
S-parameters	B3912_NB.s2p, B3912_WB.s2p see file header for port/pin assignment table
Soldering profile	S_6001
RoHS compatible	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8 th , 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.
Moldability	Before using in overmolding environment, please contact your EPCOS sales office.
Matching coils	See Inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm

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